



### N-CHANNEL ENHANCEMENT MODE MOSFET

## **Product Summary**

| BV <sub>DSS</sub> | R <sub>DS(ON)</sub>      | Package               | I <sub>D</sub><br>T <sub>C</sub> = +25°C |
|-------------------|--------------------------|-----------------------|--|
| 950V              | 7Ω@V <sub>GS</sub> = 10V | ITO220AB<br>(Type TH) | 2.5A                                     |

## **Description**

This new generation complementary dual MOSFET features low onresistance and fast switching, making it ideal for high efficiency power management applications.

## **Applications**

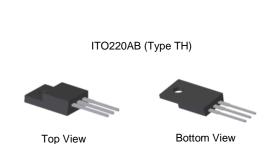
- Motor Control
- Backlighting
- DC-DC Converters
- Power Management Functions

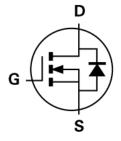
## **Features**

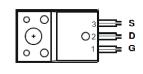
- Low Input Capacitance
- High BV<sub>DSS</sub> Rating for Power Application
- Low Input/Output Leakage
- Lead-Free Finish; RoHS Compliant (Notes 1 & 2)
- Halogen and Antimony Free. "Green" Device (Note 3)

### **Mechanical Data**

- Case: ITO220AB (Type TH)
- Case Material: Molded Plastic, "Green" Molding Compound, UL Flammability Classification Rating 94V-0
- Terminals: Matte Tin Finish Annealed over Copper Leadframe. Solderable per MIL-STD-202, Method 208 (3)
- Terminal Connections: See Diagram Below
- Weight: 1.85 grams (Approximate)







Equivalent Circuit

Top View Pin Out Configuration

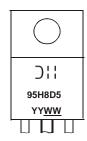
## Ordering Information (Note 4)

| Part Number   | Case               | Packaging      |  |
|---------------|--------------------|----------------|--|
| DMN95H8D5HCTI | ITO220AB (Type TH) | 50 Pieces/Tube |  |

Notes:

- 1. EU Directive 2002/95/EC (RoHS) & 2011/65/EU (RoHS 2) compliant. All applicable RoHS exemptions applied.
- 2. See http://www.diodes.com/quality/lead\_free.html for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free.
- 3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.
- 4. For packaging details, go to our website at https://www.diodes.com/design/support/packaging/diodes-packaging/

# **Marking Information**



Jil = Manufacturer's Marking
 95H8D5 = Product Type Marking Code
 YYWW = Date Code Marking
 YY or YY = Last Two Digits of Year (ex: 17 = 2017)
 WWor WW = Week Code (01 to 53)



# **Maximum Ratings** (@T<sub>A</sub> = +25°C, unless otherwise specified.)

| Characteristic  |   |                | Value | Unit |
|---|---|----------------|-------|------|
| Drain-Source Voltage  |   |                | 950   | V    |
| Gate-Source Voltage   |   |                | ±30   | V    |
| Continuous Drain Current (Notes 5)<br>V <sub>GS</sub> = 10V | $T_C = +25^{\circ}C$<br>$T_C = +100^{\circ}C$ | I <sub>D</sub> | А     | А    |
| Pulsed Drain Current (Note 6)                               |   |                | 3     | Α    |
| Avalanche Current, L = 60mH (Note 7)                        |   |                | 1.8   | Α    |
| Avalanche Energy, L = 60mH (Note 7)                         |   |                | 97    | mJ   |
| Peak Diode Recovery dv/dt (Note 7)                          |   |                | 3.3   | V/ns |

## **Thermal Characteristics**

| Characteristic  |   |                                   | Max         | Unit |
|---|---|-----------------------------------|-------------|------|
| Power Dissipation (Note 5)                              | $T_{C} = +25^{\circ}C$<br>$T_{C} = +100^{\circ}C$ | P <sub>D</sub>                    | 30<br>12    | W    |
| Thermal Resistance, Junction to Case (Note 5) $T_C = +$ |   | $R_{\theta JC}$                   | 4.2         | °C/W |
| Operating and Storage Temperature Range                 |   | T <sub>J</sub> , T <sub>STG</sub> | -55 to +150 | °C   |

# Electrical Characteristics (@T<sub>A</sub> = +25°C, unless otherwise specified.)

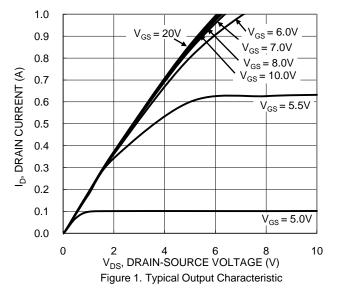
| Characteristic                     | Symbol              | Min | Тур  | Max | Unit | Test Condition  |
|------------------------------------|---------------------|-----|------|-----|------|---|
| OFF CHARACTERISTICS (Note 8)       |                     |     |      |     |      |   |
| Drain-Source Breakdown Voltage     | BV <sub>DSS</sub>   | 950 | _    |     | V    | $V_{GS} = 0V, I_D = 250\mu A$                             |
| Zero Gate Voltage Drain Current    | I <sub>DSS</sub>    |     | _    | 1   | μΑ   | $V_{DS} = 950V, V_{GS} = 0V$                              |
| Gate-Source Leakage                | I <sub>GSS</sub>    |     | _    | 100 | nA   | $V_{GS} = \pm 30V$ , $V_{DS} = 0V$                        |
| ON CHARACTERISTICS (Note 8)        |                     |     |      |     |      |   |
| Gate Threshold Voltage             | V <sub>GS(TH)</sub> | 3.0 | _    | 5.0 | V    | $V_{DS} = V_{GS}$ , $I_D = 250\mu A$                      |
| Static Drain-Source On-Resistance  | R <sub>DS(ON)</sub> | _   | 5.5  | 7.0 | Ω    | $V_{GS} = 10V, I_D = 1A$                                  |
| Diode Forward Voltage              | V <sub>SD</sub>     | _   | —    | 1.2 | V    | $V_{GS} = 0V$ , $I_S = 2A$                                |
| DYNAMIC CHARACTERISTICS (Note 7)   |                     |     |      |     |      |   |
| Input Capacitance                  | Ciss                | _   | 470  | _   | pF   | $V_{DS} = 25V, f = 1.0MHz, V_{GS} = 0V$                   |
| Output Capacitance                 | Coss                |     | 45   | _   |      |   |
| Reverse Transfer Capacitance       | C <sub>rss</sub>    |     | 0.6  | _   |      |   |
| Gate Resistance                    | $R_g$               | _   | 1.2  | _   | Ω    | $V_{DS} = 0V, V_{GS} = 0V, f = 1.0MHz$                    |
| Total Gate Charge                  | $Q_g$               |     | 7.9  | _   |      | $V_{DD} = 720V, I_D = 2A,$<br>$V_{GS} = 10V$              |
| Gate-Source Charge                 | $Q_{gs}$            | _   | 2.5  | _   | nC   |   |
| Gate-Drain Charge                  | $Q_{gd}$            |     | 2.9  | _   |      |   |
| Turn-On Delay Time                 | t <sub>D(ON)</sub>  |     | 16   | _   |      | $V_{DD} = 450V, R_g = 25\Omega, I_D = 2A,$ $V_{GS} = 10V$ |
| Turn-On Rise Time                  | t <sub>R</sub>      |     | 21   | _   | ns   |   |
| Turn-Off Delay Time                | t <sub>D(OFF)</sub> |     | 17.6 | _   |      |   |
| Turn-Off Fall Time                 | t <sub>F</sub>      |     | 17   | _   |      |   |
| Body Diode Reverse Recovery Time   | t <sub>RR</sub>     | _   | 375  | _   | ns   | $dI/dt = 100A/\mu s$ , $V_{DS} = 100V$ ,                  |
| Body Diode Reverse Recovery Charge | Q <sub>RR</sub>     | _   | 2.9  | _   | μC   | I <sub>F</sub> = 2A                                       |

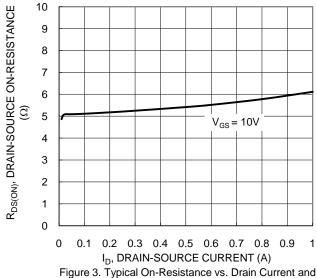
Notes:

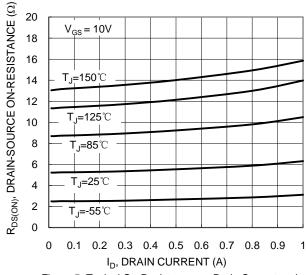
- 5. Device mounted on infinite heatsink.
- Device mounted on FR-4 substrate PC board, 2oz copper, with minimum recommended pad layout.
  Guaranteed by design. Not subject to production testing.
  Short duration pulse test used to minimize self-heating effect.





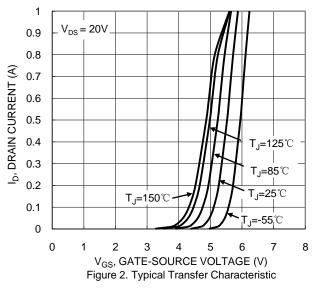






Gate Voltage

Figure 5. Typical On-Resistance vs. Drain Current and Temperature



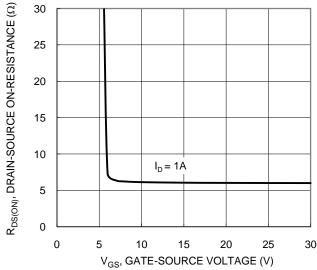


Figure 4. Typical Transfer Characteristic

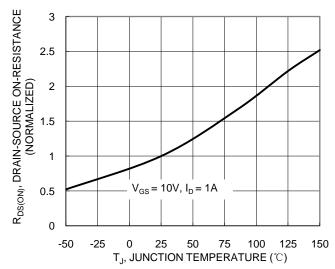


Figure 6. On-Resistance Variation with Temperature





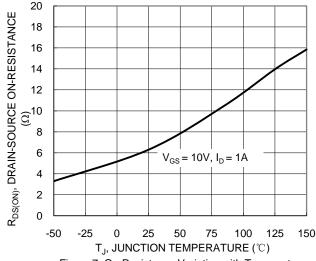


Figure 7. On-Resistance Variation with Temperature

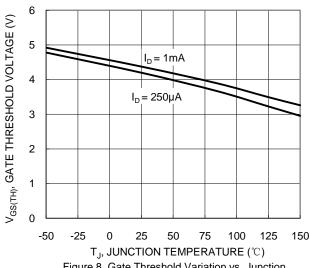


Figure 8. Gate Threshold Variation vs. Junction Temperature

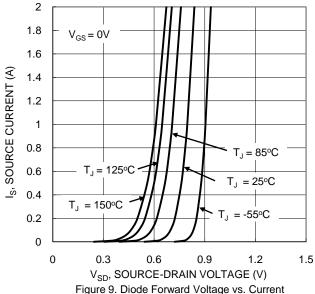
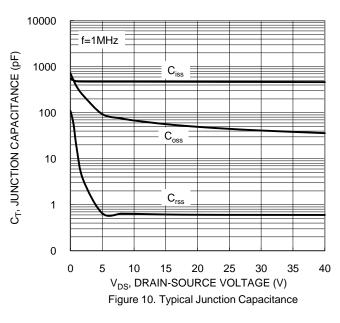
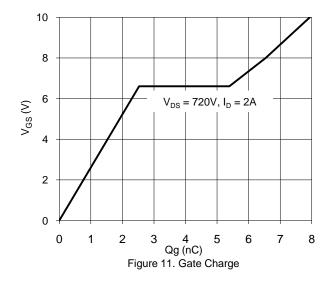
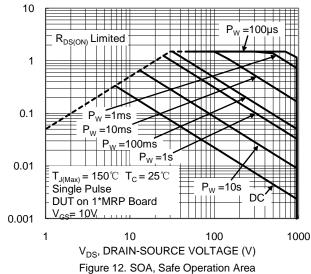


Figure 9. Diode Forward Voltage vs. Current







ID, DRAIN CURRENT (A)



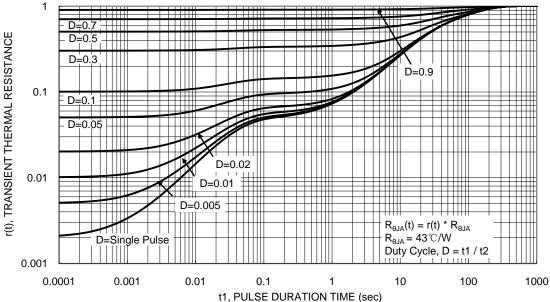


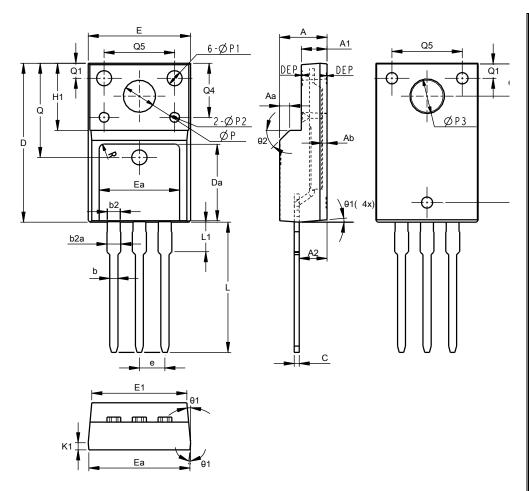
Figure 13. Transient Thermal Resistance



# **Package Outline Dimensions**

Please see http://www.diodes.com/package-outlines.html for the latest version.

### ITO220AB (Type TH)



| ITO220AB (Type TH)   |                |        |       |  |  |  |
|----------------------|----------------|--------|-------|--|--|--|
| Dim                  | Min            | Max    | Тур   |  |  |  |
| Α                    | 4.50           | 4.90   | 4.70  |  |  |  |
| A1                   | 2.34           | 2.74   | 2.54  |  |  |  |
| A2                   | 2.63           | 2.89   | 2.76  |  |  |  |
| Aa                   | 1.00 REF       |        |       |  |  |  |
| Ab                   | 0.30           | 0.60   | 0.56  |  |  |  |
| b                    | 0.75           | 0.90   | 0.80  |  |  |  |
| b2                   | 1.23           | 1.38   | 1.28  |  |  |  |
| b2a                  | 1.25           | 1.45   | 1.35  |  |  |  |
| С                    | 0.45           | 0.60   | 0.50  |  |  |  |
| D                    | 15.47          | 16.27  | 15.87 |  |  |  |
| Da                   | 7.55           | 8.05   | 7.80  |  |  |  |
| е                    | 2              | .54 BS | С     |  |  |  |
| Е                    | 9.86           | 10.46  | 10.16 |  |  |  |
| E1                   | 9.26           | 9.66   | 9.46  |  |  |  |
| Ea                   | 7.70           | 8.30   | 8.00  |  |  |  |
| Eb                   | 9.76           | 10.34  | 10.04 |  |  |  |
| H1                   | 6              | .70 RE | F     |  |  |  |
| L                    | 12.58          | 13.38  | 12.98 |  |  |  |
| L1                   | 2.81           | 3.05   | 2.93  |  |  |  |
| <b>K</b> 1           | 0.65           | 0.75   | 0.70  |  |  |  |
| Q                    | 9              | .40 RE | F     |  |  |  |
| Q1                   | 1.00           | 2.00   | 1.50  |  |  |  |
| Q2                   | 13.50          | 14.30  | 13.90 |  |  |  |
| Q3                   | 3.15           | 3.45   | 3.30  |  |  |  |
| Q4                   | 5.15           | 5.65   | 5.40  |  |  |  |
| Q5                   | 6.70           | 7.30   | 7.00  |  |  |  |
| ØP                   | 3.06           | 3.40   | 3.18  |  |  |  |
| ØP1                  | 1.40           | 1.60   | 1.50  |  |  |  |
| ØP2                  | 0.95           | 1.05   | 1.00  |  |  |  |
| ØP3                  | 3.30           | 3.60   | 3.45  |  |  |  |
| θ1                   | 3º             | 7º     | 5º    |  |  |  |
| θ2                   | -              | 45°    | -     |  |  |  |
| R                    | 0.50 REF       |        |       |  |  |  |
| DEP                  | 0.05 0.15 0.10 |        |       |  |  |  |
| All Dimensions in mm |                |        |       |  |  |  |



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